



#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>A</sub> = +25°C
	2.0Ω @Vgs = 5.0V	455mA
60V	2.5Ω @Vgs = 2.5V	427mA
	4.0Ω @V <sub>GS</sub> = 1.8V	358mA

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- General-purpose interfacing switches
- Power-management functions

### **Features and Benefits**

- Low On-Resistance
- Very Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

An automotive-compliant part is available under separate datasheet (DMN62D2UVTQ)

#### **Mechanical Data**

- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.013 grams (Approximate)

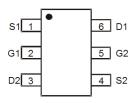




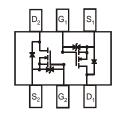
TSOT26



Top View



Top View Pin Configuration



Top View Internal Schematic

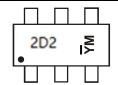
#### Ordering Information (Note 4)

Part Number	Pankaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMN62D2UVT-7	TSOT26	3,000	Tape & Reel	
DMN62D2UVT-13	TSOT26	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

### **Marking Information**



2D2 = Product Type Marking Code YM = Date Code Marking  $\overline{Y}$ = Year (ex: K = 2023) M = Month (ex: N = November)

Date Code Key

Year	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	K	L	М	N	Р	R	S	Т	U	V	W	Χ
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	VDSS	60	V		
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) $V_{GS} = 5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			lo	455 364	mA
Maximum Continuous Body Diode Forward Current	(Note 6)		Is	455	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	6)	IDM	1.2	Α	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1	l%)		lsм	1.2	Α

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	0.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	254	°C/W
Total Power Dissipation (Note 6)		PD	0.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	143	°C/W
Thermal Resistance, Junction to Case (Note 6)		R <sub>θ</sub> JC	47	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

			•	•			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	_	1.0	μΑ	$V_{DS} = 60V$ , $V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±10	μΑ	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	0.5	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
			1.1	2.0		$V_{GS} = 5.0V, I_{D} = 0.05A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		1.2	2.5	Ω	$V_{GS} = 2.5V, I_D = 0.05A$	
			1.6	4.0		$V_{GS} = 1.8V, I_D = 0.05A$	
Diode Forward Voltage	VsD	_	0.7	1.4	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	—	41		pF	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	
Output Capacitance	Coss	_	5.4	_	pF	$V_{DS} = 30V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	4.2	_	pF	1 = 1.0WH12	
Gate Resistance	Rg	_	52	_	Ω	$f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$	
Total Gate Charge	Qg	_	0.8	_	nC	45)/ // 40)/	
Gate-Source Charge	Qgs	_	0.2	_	nC	Vgs = 4.5V, Vps = 10V, Ip = 250mA	
Gate-Drain Charge	Qgd	_	0.1	_	nC	ID = 250MA	
Turn-On Delay Time	t <sub>D</sub> (ON)	_	1.5	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	9.7	_	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	22.6	_	ns	$R_G = 25\Omega$ , $I_D = 200 \text{mA}$	
Turn-Off Fall Time	tF	_	19.5	_	ns		
Reverse Recovery Time	t <sub>RR</sub>	_	383	_	ns	I <sub>F</sub> = 1A, di/dt = 100A/µs	
Reverse Recovery Charge	Qrr	_	474	_	nC	I <sub>F</sub> = 1A, di/dt = 100A/μs	

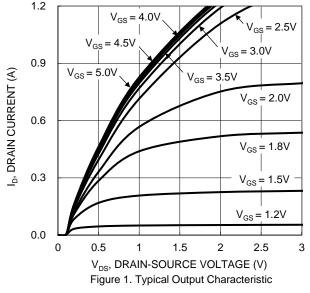
5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to product testing.







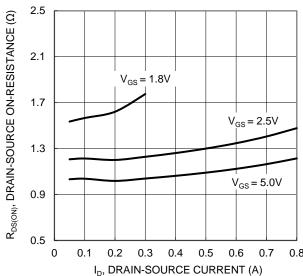


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

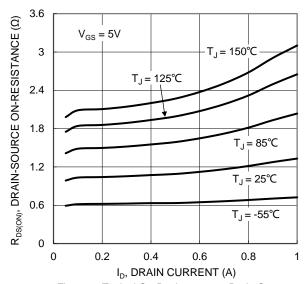
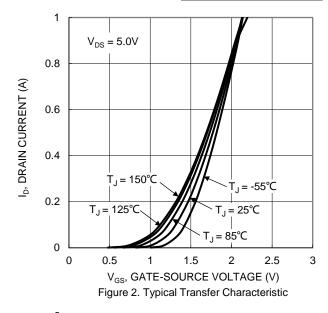
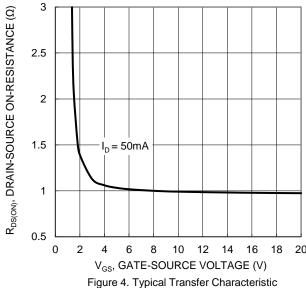


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





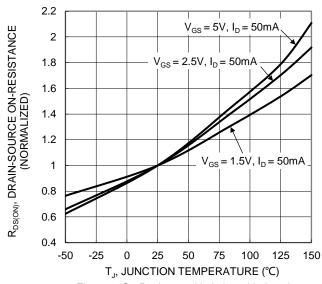


Figure 6. On-Resistance Variation with Junction Temperature





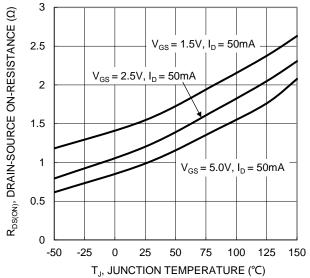


Figure 7. On-Resistance Variation with Junction Temperature

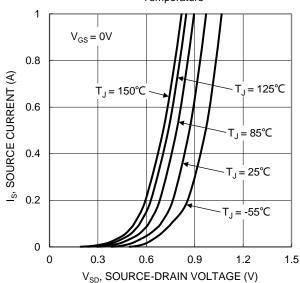


Figure 9. Diode Forward Voltage vs. Current

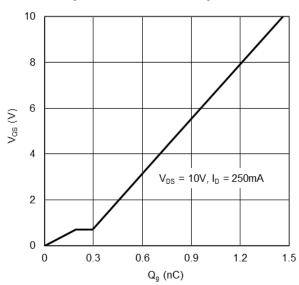


Figure 11. Gate Charge

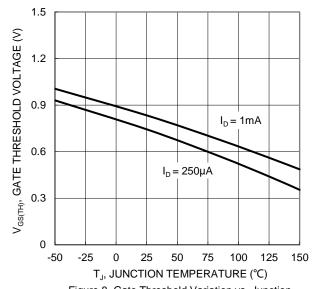
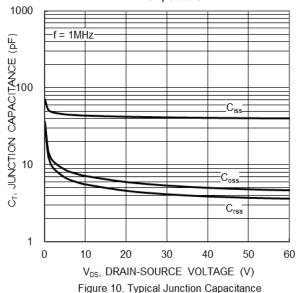


Figure 8. Gate Threshold Variation vs. Junction Temperature



10 R<sub>DS(ON)</sub> Limited  $P_W = 100 \mu s$ ID, DRAIN CURRENT (A) 0.1  $T_{J(Max)} = 150$ °C  $P_W = 1s$ 0.01  $T_{\Delta} = 25^{\circ}C$ Single Pulse DC DUT on 1\*MRP Board  $V_{GS} = 5V$ 0.001 0.1 10 100  $V_{DS}$ , DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



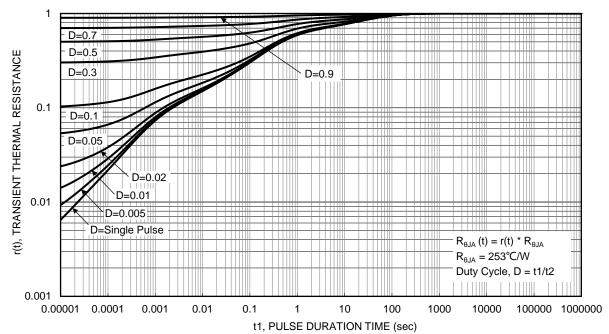


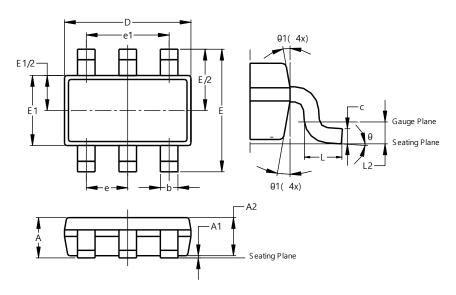
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26

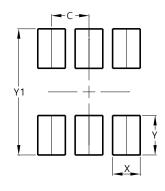


TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
<b>A</b> 1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
Е	2	.800 BS	С				
E1	1.500	1.500 1.700					
b	0.300	0.450	-				
С	0.120	0.200	_				
е	0.950 BSC						
e1	1.900 BSC						
L	0.30	0.50	-				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	-				
A	All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
V1	3 200



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